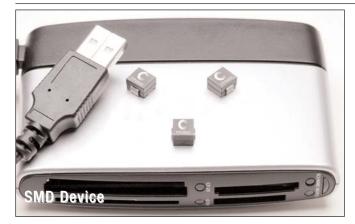
COILTRONICS

High Current, High Frequency, Low-Profile Power Inductors

FLAT-PAC[™] FP0805 Series



Description

- Halogen free
- 125°C maximum total temperature operation
- 7.5 x 7.6 x 5mm surface mount package
- Ferrite core material
- · High current carrying capacity, Low core losses
- Controlled DCR tolerance for sensing circuits
- Inductance range from 32nH to 200nH
- Current range from 20 to 110 Amps
- Frequency range up to 2MHz
- · RoHS compliant

Applications

- Multi-phase regulators
- Voltage Regulator Module (VRM)
- · Point-of-load modules
- Desktop and server VRM's and EVRD's
- Data networking and storage systems
- Notebook regulators
- Graphics cards and battery power systems
- DCR sensing

Environmental Data

- Storage temperature range: -40°C to +125°C
- Operating temperature range: -40°C to +125°C (Range is application specific)

RoHS 2002/95/EC

• Solder reflow temperature: J-STD-020D compliant

Packaging

• Supplied in tape and reel packaging, 950 parts per reel, 13 inch diameter reel.

Product Specifications							
Part Number ⁷	0CL1 ± 10% (nH)	FLL ² Min. (nH)	I _{rms} ³ (Amps)	I _{sat} 1⁴ @ 25°C (Amps)	I _{sat} 2 ⁵ @ 125°C (Amps)	DCR (mΩ) @ 20°C	K-factor ⁶
FP0805R1-R03-R	32	23		110	95		823.6
FP0805R1-R06-R	58	42		83	61		823.6
FP0805R1-R07-R	72	52	65	67	49	0.17 ± 17%	823.6
FP0805R1-R10-R	100	72]	50	35		823.6
FP0805R1-R20-R	200	144		20	16		823.6

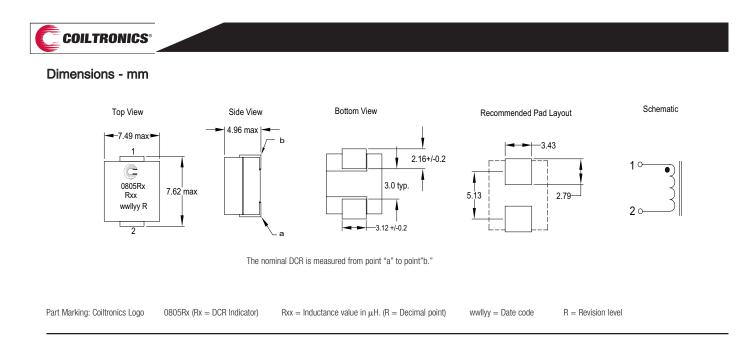
- 1 Open Circuit Inductance (OCL) Test Parameters: 100kHz, 0.10Vrms, 0.0Adc
- 2 Full Load Inductance (FLL) Test Parameters: 100kHz, $0.1V_{rms}$, $I_{sat}1$
- 3 I_{rms}: DC current for an approximate temperature rise of 40°C without core loss. Derating is necessary for AC currents. PCB pad layout, trace thickness and width, air-flow and proximity of other heat generating components will affect the temperature rise. It is recommended the part temperature not exceed 125°C under worst case operating conditions verified in the end application.
- 4 Isat1: Peak current for approximately 20% rolloff at +25°C.
- 5 Isat2: Peak current for approximately 20% rolloff at +125°C.
- 6 K-factor: Used to determine B_{p-p} for core loss (see graph). B_{p-p} = K * L * ΔI * 10⁻³, B_{p-p} : (Gauss), K: (K-factor from table), L: (inductance in nH), ΔI (peak-to-peak ripple current in amps).
- 7 Part Number Definition: FP0805Rx-Rxx-R
 - FP0805 = Product code and size
 - Rxx= Inductance value in μ H, R = decimal point "-R" suffix = RoHS compliant

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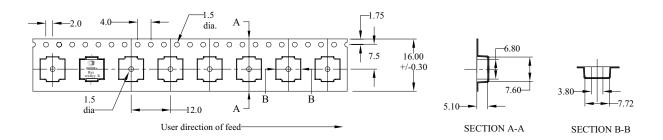




• Rx is the DCR indicator

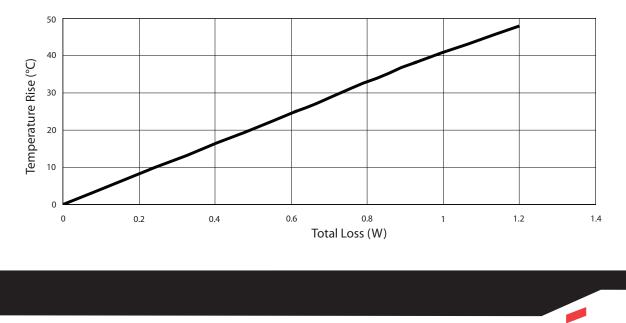


Packaging Information - mm



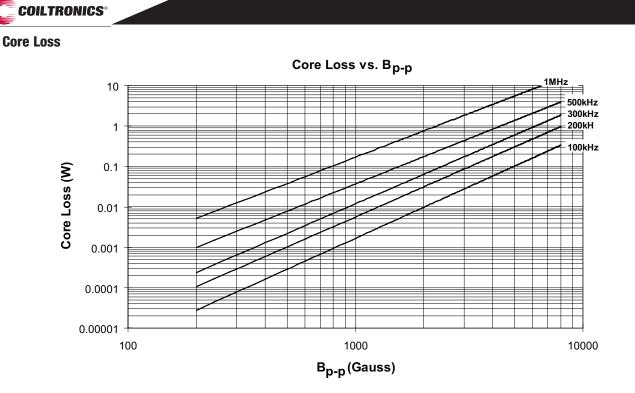
Supplied in tape-and-reel packaging, 950 parts per reel, 13" diameter reel.

Temperature Rise vs.Total Loss

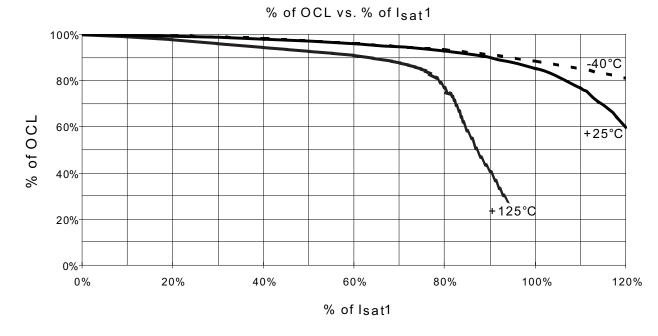


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Inductance Characteristics



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Solder Reflow Profile

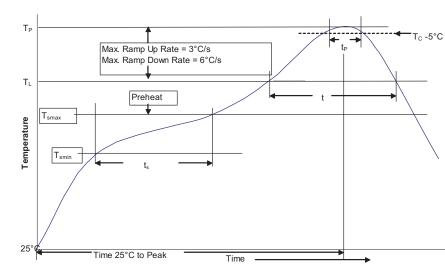


Table 1 - Standard SnPb Solder (T _c)				
Package	Volume mm ³	Volume mm ³		
Thickness	<350	≥350		
<2.5mm	235°C	220°C		
≥2.5mm	220°C	220°C		

Table 2 - Lead (Pb) Free Solder (T_c)

Package Thickness	Volume mm ³ <350	Volume mm³ 350 - 2000	Volume mm³ >2000
<1.6mm	260°C	260°C	260°C
1.6 – 2.5mm	260°C	250°C	245°C
>2.5mm	250°C	245°C	245°C

Reference JDEC J-STD-020D

Profile Feature		Standard SnPb Solder	Lead (Pb) Free Solder	
Preheat and Soak	 Temperature min. (T_{smin}) 	100°C	150°C	
	 Temperature max. (T_{smax}) 	150°C	200°C	
	 Time (T_{smin} to T_{smax}) (t_s) 	60-120 Seconds	60-120 Seconds	
Average ramp up rate T_{smax} to T_p		3°C/ Second Max.	3°C/ Second Max.	
Liquidous temperature (TL)		183°C	217°C	
Time at liquidous (t _L)		60-150 Seconds	60-150 Seconds	
Peak package body temperature (TP)*		Table 1	Table 2	
Time $(t_p)^{**}$ within 5 °C of the specified classification temperature (T_c)		20 Seconds**	30 Seconds**	
Average ramp-down rate (Tp to T _{smax})		6°C/ Second Max.	6°C/ Second Max.	
Time 25°C to Peak Temperature		6 Minutes Max.	8 Minutes Max.	

 * Tolerance for peak profile temperature (T_p) is defined as a supplier minimum and a user maximum.

** Tolerance for time at peak profile temperature (t_p) is defined as a supplier minimum and a user maximum.

Asia Pacific North America Cooper Electronic Technologies Europe Cooper Electronic Technologies Cooper Bussmann Cooper Electronic Technologies Avda. Santa Eulalia, 290 **Cooper Electronic Technologies** 1225 Broken Sound Parkway NW P.O. Box 14460 Cooper (UK) Limited 1 Jalan Kilang Timor Suite F St. Louis, MO 63178-4460 Burton-on-the-Wolds #06-01 Pacific Tech Centre 08223 Boca Raton, FL 33487-3533 Tel: 1-636-394-2877 Leicestershire • LE12 5TH UK Terrassa, (Barcelona), Spain Singapore 159303 Tel: +34 937 362 812 +34 937 362 813 Tel: 1-561-998-4100 Fax: 1-636-527-1607 Tel: +44 (0) 1509 882 737 Tel: +65 278 6151 Fax: 1-561-241-6640 Fax: +44 (0) 1509 882 786 Fax: +65 270 4160 Toll Free: 1-888-414-2645 Fax: +34 937 362 719 The only controlled copy of this Data Sheet is the electronic read-only version located on the Cooper Bussmann Network Drive. All other copies of this document are by definition uncontrolled. This bulletin is intended to clearly present comprehensive product data and provide technical information that will help the end user with design applications. Cooper Bussmann reserves the right, without notice, to change design or construction of any products and to discontinue or limit distribution of any products. Cooper Bussmann also reserves the right to change or update, without notice, any technical information contained in this bulletin. Once a product has been selected, it should be tested by the user in all possible applications. Life Support Policy: Cooper Bussmann does not authorize the use of any of its products for use in life support devices or systems without the express written approval of an officer of the Company. Life support systems are devices which support or sustain life, and whose failure to perform, when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in significant injury to the user.

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